# SPDT SUBMINIATURE POWER RELAY

## FEATURES

- 5 kV dielectric strength, 10 kV surge
- 8mm creepage and clearance
- Proof tracking index (PTI/CTI) 250
- 5 Amp switching (1 Form A: 20A inrush)
- Epoxy sealed version available
- Reinforced insulation, EN 60730-1 (VDE 0631, part 1), 1 Form A: EN 60335-1 (VDE 0700, part 1)
- UL, CUR file E44211
- VDE file 40006815

## CONTACTS



COIL

Power	
At Pickup Voltage (typical)	253 mW standard coil 113 mW sensitive coil
Max. Continuous Dissipation	1.25 W at 20°C (68°F) ambient
Temperature Rise (at nominal voltage)	41°C (74°F) standard coil 22°C (40°F) sensitive coil
Temperature	Max. 130°C (266°F)

#### NOTES

- 1. All values at 20°C (68°F).
- 2. Relay may pull in with less than "Must Operate" value.
- 3. Specifications subject to change without notice.

# ZETTLER electronics GmbH

Junkersstrasse 3, D-82178 Puchheim, Germany



### GENERAL DATA

Life Expectancy Mechanical ElectricalMinimum operations 1 × 106 1 × 105 at 5 A 250 VAC Res.Operate Time (typical)8 ms at nominal coil voltageRelease Time (typical)4 ms at nominal coil voltage (with no coil suppression)Dielectric Strength (at sea level for 1 min.)5000 Vrms coil to contact 1000 Vrms between open contactsSurge Voltage Coil to contact10,000V (at 1.2x50 µs)Insulation (according to DIN VDE 0110, IBC 60664-1)0000 megohms min. at 20°C So0 VDC 50% RHDropoutGreater than 5% of nominal coil voltage -40°C (-40°F) to 85°C (185°F) -40°C (-40°F) to 105°C (221°F)Vibration0.062" (1.5 mm) DA at 10–50 HzShock10 g operating, 100 g damageEnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Time Max. Solvent Temp.30 secondsMean Weight4.6 grams				
Electrical1 x 105 at 5 A 250 VAC Res.Operate Time (typical)8 ms at nominal coil voltage (with no coil suppression)Release Time (typical)4 ms at nominal coil voltage (with no coil suppression)Dielectric Strength (at sea level for 1 min.)5000 Vrms coil to contact 1000 Vrms between open contactsSurge Voltage Coil to contact10,000V (at 1.2x50 µs)Insulation (according to DIN VDE 0110, IEC 60664-1)C250 Overvoltage category: III Pollution degree: 3 Nominal voltage: 250 VACDropoutGreater than 5% of nominal coil voltage -40°C (-40°F) to 85°C (185°F) -40°C (-40°F) to 105°C (221°F)Vibration Shock0.062" (1.5 mm) DA at 10–50 HzShock10 g operating, 100 g damageEnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Temp.270°C (518°F) 30 secondsMax. Immersion Time30 secondsWeight4.6 grams		•		
Release Time (typical)4 ms at nominal coil voltage (with no coil suppression)Dielectric Strength (at sea level for 1 min.)5000 Vrms coil to contact 1000 Vrms between open contactsSurge Voltage Coil to contact10,000V (at 1.2x50 μs)Insulation (according to DIN VDE 0110, IEC 60664-1)1000 megohms min. at 20°C 500 VDC 50% RHDiv VDE 0110, IEC 60664-1)C250 Overvoltage category: III Pollution degree: 3 Nominal voltage: 250 VACDropoutGreater than 5% of nominal coil voltage -40°C (-40°F) to 85°C (185°F) -40°C (-40°F) to 105°C (221°F)Vibration0.062" (1.5 mm) DA at 10–50 HzShock10 g operating, 100 g damageEnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Temp.270°C (518°F) 4.6 gramsMax. Immersion Time30 secondsWeight4.6 grams				
(with no coil suppression)Dielectric Strength (at sea level for 1 min.)5000 Vrms coil to contact 1000 Vrms between open contactsSurge Voltage Coil to contact10,000V (at 1.2x50 µs)Insulation (according to DIN VDE 0110, IEC 60664-1)1000 megohms min. at 20°C So0 VDC 50% RHInsulation (according to DropoutC250 Overvoltage category: III Pollution degree: 3 Nominal voltage: 250 VACDropoutGreater than 5% of nominal coil voltage -40°C (-40°F) to 85°C (185°F) -40°C (-40°F) to 105°C (221°F)Vibration0.062" (1.5 mm) DA at 10–50 HzShock10 g operating, 100 g damageEnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Temp.270°C (518°F) 30 secondsMax. Immersion Time30 secondsWeight4.6 grams	Operate Time (typical)	8 ms at nominal coil voltage		
(at sea level for 1 min.)1000 Vrms between open contactsSurge Voltage Coil to contact10,000V (at 1.2x50 μs)Insulation (according to DIN VDE 0110, IEC 60664-1)1000 megohms min. at 20°C 500 VDC 50% RHInsulation (according to DIN VDE 0110, IEC 60664-1)C250 Overvoltage category: III Pollution degree: 3 Nominal voltage: 250 VACDropoutGreater than 5% of nominal coil voltage -40°C (-40°F) to 85°C (185°F) -40°C (-40°F) to 105°C (221°F)Vibration0.062" (1.5 mm) DA at 10–50 HzShock10 g operating, 100 g damageEnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Temp.270°C (518°F) 30 secondsMax. Immersion Time30 secondsWeight4.6 grams	Release Time (typical)			
Coil to contact10,000V (at 1.2x50 μs)Insulation Resistance1000 megohms min. at 20°C 500 VDC 50% RHInsulation (according to DIN VDE 0110, IEC 60664-1)C250 Overvoltage category: III Pollution degree: 3 Nominal voltage: 250 VACDropoutGreater than 5% of nominal coil voltage -40°C (-40°F) to 85°C (185°F) -40°C (-40°F) to 105°C (221°F)Vibration0.062" (1.5 mm) DA at 10–50 HzShock10 g operating, 100 g damageEnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Temp.80°C (176°F)Max. Immersion Time30 secondsWeight4.6 grams				
Resistance500 VDC 50% RHInsulation (according to DIN VDE 0110, IEC 60664-1)C250 Overvoltage category: III Pollution degree: 3 Nominal voltage: 250 VACDropoutGreater than 5% of nominal coil voltage -40°C (-40°F) to 85°C (185°F) -40°C (-40°F) to 105°C (221°F)Vibration0.062" (1.5 mm) DA at 10–50 HzShock10 g operating, 100 g damageEnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Temp.80°C (176°F)Max. Solvent Temp.80°C (176°F)Max. Immersion Time30 secondsWeight4.6 grams		10,000V (at 1.2x50 μs)		
(according to DIN VDE 0110, IEC 60664-1)Overvoltage category: III Pollution degree: 3 Nominal voltage: 250 VACDropoutGreater than 5% of nominal coil voltageAmbient Temperature Operating StorageAt nominal coil voltage -40°C (-40°F) to 85°C (185°F) -40°C (-40°F) to 105°C (221°F)Vibration0.062" (1.5 mm) DA at 10–50 HzShock10 g operating, 100 g damageEnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Temp.270°C (518°F) S secondsMax. Solvent Temp.80°C (176°F)Max. Immersion Time30 secondsWeight4.6 grams				
Ambient Temperature Operating StorageAt nominal coil voltage -40°C (-40°F) to 85°C (185°F) -40°C (-40°F) to 105°C (221°F)Vibration0.062" (1.5 mm) DA at 10–50 HzShock10 g operating, 100 g damageEnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Temp.270°C (518°F)Max. Solvent Temp.80°C (176°F)Max. Immersion Time30 secondsWeight4.6 grams	(according to DIN VDE 0110,	Overvoltage category: III Pollution degree: 3		
Operating Storage-40°C (-40°F) to 85°C (185°F) -40°C (-40°F) to 105°C (221°F)Vibration0.062" (1.5 mm) DA at 10–50 HzShock10 g operating, 100 g damageEnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Temp.270°C (518°F)Max. Solder Time5 secondsMax. Solvent Temp.80°C (176°F)Max. Immersion Time30 secondsWeight4.6 grams	Dropout	Greater than 5% of nominal coil voltage		
Shock   10 g operating, 100 g damage     Enclosure   P.B.T. polyester     Terminals   Tinned copper alloy, P.C.     Max. Solder Temp.   270°C (518°F)     Max. Solder Time   5 seconds     Max. Solvent Temp.   80°C (176°F)     Max. Immersion Time   30 seconds     Weight   4.6 grams	Operating	-40°C (-40°F) to 85°C (185°F)		
EnclosureP.B.T. polyesterTerminalsTinned copper alloy, P.C.Max. Solder Temp.270°C (518°F)Max. Solder Time5 secondsMax. Solvent Temp.80°C (176°F)Max. Immersion Time30 secondsWeight4.6 grams	Vibration	0.062" (1.5 mm) DA at 10–50 Hz		
TerminalsTinned copper alloy, P.C.Max. Solder Temp.270°C (518°F)Max. Solder Time5 secondsMax. Solvent Temp.80°C (176°F)Max. Immersion Time30 secondsWeight4.6 grams	Shock	10 g operating, 100 g damage		
Max. Solder Temp.270°C (518°F)Max. Solder Time5 secondsMax. Solvent Temp.80°C (176°F)Max. Immersion Time30 secondsWeight4.6 grams	Enclosure	P.B.T. polyester		
Max. Solder Time5 secondsMax. Solvent Temp.80°C (176°F)Max. Immersion Time30 secondsWeight4.6 grams	Terminals	Tinned copper alloy, P.C.		
Max. Solvent Temp. 80°C (176°F)   Max. Immersion Time 30 seconds   Weight 4.6 grams	Max. Solder Temp.	270°C (518°F)		
Max. Immersion Time 30 seconds   Weight 4.6 grams	Max. Solder Time	5 seconds		
Weight 4.6 grams	Max. Solvent Temp.	80°C (176°F)		
	Max. Immersion Time	30 seconds		
	Weight	4.6 grams		
Packing unit in pcs 100 per plastic tray / 1000 per carton box	Packing unit in pcs	100 per plastic tray / 1000 per carton box		

# AZ770.

## RELAY ORDERING DATA

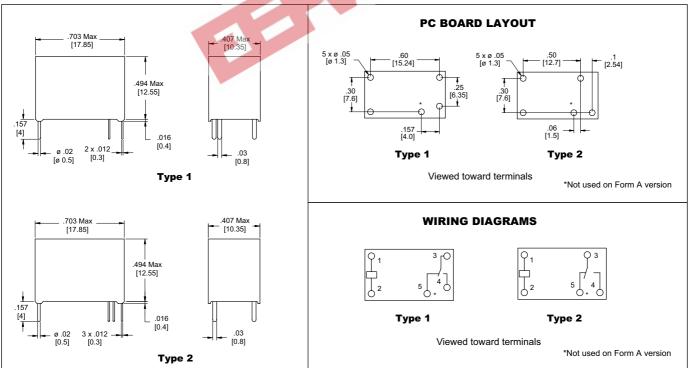
STANDARD RELAYS – TYPE 1 FOOTPRINT						
COIL SPECIFICATIONS			ORDER NUMBER*			
Nominal Coil VDC	Must Operate VDC	Max. Continuous VDC	Coil Resistance Ohm ±10%	Form A (SPST)	Form C (SPDT)	
3	2.25	3.9	20	AZ770–1A–3D	AZ770–1C–3D	
5	3.75	6.5	55	AZ770–1A–5D	AZ770–1C–5D	
6	4.5	7.8	80	AZ770–1A–6D	AZ770–1C–6D	
9	6.75	11.7	180	AZ770–1A–9D	AZ770-1C-9D	
12	9.0	15.6	320	AZ770–1A–12D	AZ770–1C–12D	
18	13.5	23.4	720	AZ770–1A–18D	AZ770–1C–18D	
24	18.0	31.2	1,280	AZ770–1A–24D	AZ770–1C–24D	
48	36.0	62.4	5,120 ±15%	AZ770–1A–48D	AZ770–1C–48D	

### SENSITIVE RELAYS - TYPE 1 FOOTPRINT

COIL SPECIFICATIONS			ORDER NUMBER*		
Nominal Coil VDC	Must Operate VDC	Max. Continuous VDC	Coil Resistance Ohm ± 10%	Form A (SPST)	
3	2.25	5.1	45	AZ770–1A–3DS	
5	3.75	8.5	125	AZ770–1A–5DS	
6	4.5	10.2	180	42770–1A–6DS	
9	6.75	15.3	400	AZ770–1A–9DS	
12	9.0	20.4	720	AZ770–1A–12DS	
18	13.5	30.6	1,600	AZ770–1A–18DS	
24	18.0	40.8	2,800	AZ770–1A–24DS	
48	36.0	81.6	11,520 ±15%	AZ770–1A–48DS	

\* Add suffix "E" for epoxy sealed version. Add suffix "K" for Type 2 footprint. Add suffix "G" for gold plated contacts.

### MECHANICAL DATA



Dimensions in inches with metric equivalents in parentheses. Tolerance:  $\pm$  .010"

# ZETTLER electronics GmbH

office@ZETTLERelectronics.com www.ZETTLERelectronics.com